

Z21 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.

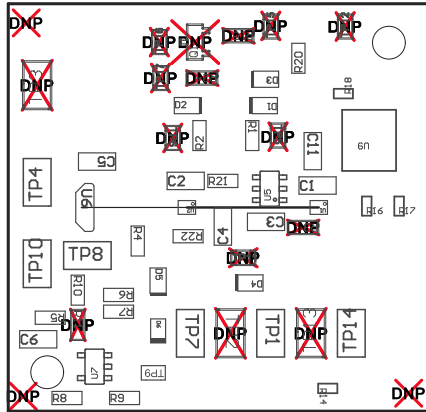
Z22 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

Z23 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Z24 ■ Please place a 0-Ohm resistor or solder-bridge on pads 2 and 3 (the pads that don't have a dot next to them) of the 3-pad footprint at R14, R16, R17, and R18. I

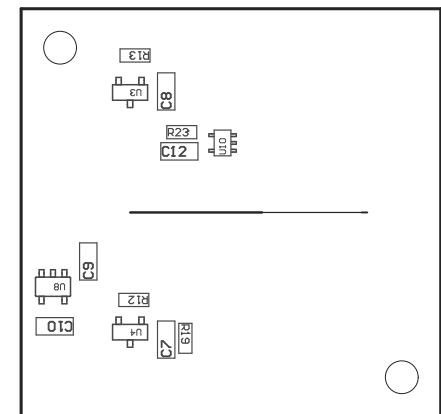
Z25 ■ Cut battery holder wire in half so that is not too long. The red wire should be soldered to the pad that has B+ to the right of it and B- to the left of it.

Z26 ■ Please solder the DRU5056(U6) so that approximately 5 mm of the leads are above the PCB.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: SENS094	REV: A	SUN REV: Not In VersionControl
	TID #: TIDA-060032		
PLOT NAME = Top Assembly Drawing	GENERATED : 12/11/2021 7:29:49 AM		TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: SENS094	REV: A	SUN REV: Not In VersionControl
	TID #: TIDA-060032		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 12/11/2021 7:29:54 AM		TEXAS INSTRUMENTS

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